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eASIC and Comcores Announce Support for C-RAN with CPRI v6.0

Santa Clara, CA – October 13th, 2014 – eASIC Corporation, a leading provider of Single Mask Adaptable ASIC™ devices and Denmark Headquartered Comcores ApS, a specialized supplier of silicon intellectual property (SIP) today announced immediate support for Common Public Radio Interface (CPRI) v.6.0 using eASIC's Nextreme-3 28nm devices enabling energy efficient and high-performance wireless C-RAN solutions. The Comcores' CPRI v6.0 Controller combined with eASIC's high performance and low power silicon architecture allows designers to deliver the highest bandwidth at the best power efficiency enabling versatile solutions for fronthaul network architectures.

"Customers building LTE-Advanced systems are adopting CPRI v6.0 to address the consumer's insatiable bandwidth requirements. This combined with the need for differentiated solutions makes eASIC Nextreme-3 28nm devices an ideal platform for rapid deployment of fronthaul technology", said Jasbinder Bhoot, Vice President of Worldwide Marketing at eASIC. "By working with Comcores, customers can use now a plug and play CPRI v6.0 solution optimized for eASIC devices, supporting virtually any radio access, optical or microwave transport, digital switching and baseband pool implementation that uses CPRI for communication."

"We are pleased to be working with eASIC to enable fronthaul applications including support for C-RAN using the eASIC platform and our CPRI v6.0 controller solution", said Thomas Noergaard, CEO of Comcores ApS. "Our optimized CPRI v6.0 core implementation targeting eASIC Nextreme-3 devices use a tiny fraction of the available resources and takes full advantage of the high performance, low power 12.5Gbps serial transceivers allowing customers to implementing custom silicon solutions that can be immediately and cost effectively taken to market without having to compromise on cost, power, performance or time-to-market."

About eASIC

eASIC is a fabless semiconductor company offering breakthrough Single Mask Adaptable ASIC devices aimed at dramatically reducing the overall cost and time-to-production of customized semiconductor devices. Low-cost, high-performance and fast-turn ASIC and System-on-Chip designs are enabled through patented technology utilizing Via-layer customizable routing. This innovative fabric allows eASIC to offer a new generation of ASICs with significantly lower up-front costs than traditional ASICs.

Privately held eASIC Corporation is headquartered in Santa Clara, California. Investors include Khosla Ventures, Kleiner Perkins Caufield and Byers (KPCB), Crescendo Ventures, Seagate Technology and Evergreen Partners. For more information on eASIC please visit www.easic.com.

About Comcores

Comcores is a fast-growing technology company that specializes in development of reusable digital intellectual property (IP) cores and solutions for wireless communication with particular focus on front hauling. State of the art know how and practical experience enabling connectivity in wireless systems are key elements in Comcores's delivery of unique, high quality, production-proven IP-cores. Comcores solutions not only accelerate development and cut costs, they increase overall design reliability and project predictability.

Privately held Comcores is headquartered in Greater Copenhagen Area, Denmark.